## PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data    |  |   |
|----------------------|--|---|
| 1.1 Company          |  | STMicroelectronics International N.V                        |
| 1.2 PCN No.          |  | ADG/24/14592  |
| 1.3 Title of PCN     |  | TO-220FP line transfer from Shenzhen to TFME Tongke (China) |
| 1.4 Product Category |  | IGBT's  |
| 1.5 Issue date       |  | 2024-03-12  |

| 2. PCN Team               |                          |  |
|---------------------------|--------------------------|--|
| 2.1 Contact supplier      |                          |  |
| 2.1.1 Name                | ROBERTSON HEATHER        |  |
| 2.1.2 Phone               | +1 8475853058            |  |
| 2.1.3 Email               | heather.robertson@st.com |  |
| 2.2 Change responsibility |                          |  |
| 2.2.1 Product Manager     | Angelo RAO               |  |
| 2.1.2 Marketing Manager   | Natale Sandro D'ANGELO   |  |
| 2.1.3 Quality Manager     | Vincenzo MILITANO        |  |

| 3. Change    |   |                            |
|--------------|---|----------------------------|
| 3.1 Category | 3.2 Type of change  | 3.3 Manufacturing Location |
|              | Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617) | TFME Tongke (China)        |

| 4. Description of change  |  |   |
|---|--|---|
|   | Old  | New   |
| 4.1 Description   | TO-220FP products are manufactured in Shenzhen (China) | TO-220FP products are manufactured in TFME Tongke (China) |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | processability   |   |

| 5. Reason / motivation for change |  |  |
|-----------------------------------|--|--|
| 5.1 Motivation                    | TO-220FP Shenzhen line closure and equipment transfer to TFME Tongke |  |
| 5.2 Customer Benefit              | SERVICE CONTINUITY   |  |

| 6. Marking of parts / traceability of change |                       |
|--|-----------------------|
| 6.1 Description                              | By dedicated FG codes |

| 7. Timing / schedule                |              |  |
|-------------------------------------|--------------|--|
| 7.1 Date of qualification results   | 2024-02-19   |  |
| 7.2 Intended start of delivery      | 2024-05-19   |  |
| 7.3 Qualification sample available? | Upon Request |  |

| 8. Qualification / Validation  |                            |                   |            |
|--|----------------------------|-------------------|------------|
| 8.1 Description 14592 RERPTD24010_1.0_TO220FP package Transfer from STS to Tongke subcon for IGBT an Bipolar transistor products.pdf |                            | ocon for IGBT and |            |
| 8.2 Qualification report and qualification results   | Available (see attachment) | Issue<br>Date     | 2024-03-12 |

## 9. Attachments (additional documentations)

| 10. Affected parts      |   |  |
|-------------------------|---|--|
| 10. 1 Current           | 10.2 New (if applicable)  |  |
| 10.1.2 Supplier Part No | 10.1.2 Supplier Part No   |  |
| 2STP535FP               |   |  |
| BDW93CFP                |   |  |
| BDW94CFP                |   |  |
| BUL1102EFP              |   |  |
| D45H11FP                |   |  |
| STGF10H60DF             |   |  |
| STGF10M65DF2            |   |  |
| STGF10NB60SD            |   |  |
| STGF10NC60KD            |   |  |
| STGF14NC60KD            |   |  |
| STGF15H60DF             |   |  |
| STGF15M65DF2            |   |  |
| STGF19NC60KD            |   |  |
| STGF20H60DF             |   |  |
| STGF20H65DFB2           |   |  |
| STGF20M65DF2            |   |  |
| STGF30M65DF2            |   |  |
| STGF3NC120HD            |   |  |
| STGF4M65DF2             |   |  |
| STGF5H60DF              |   |  |
| STGF6M65DF2             |   |  |
| STGF6NC60HD             |   |  |
| STGF7H60DF              |   |  |
| STGF7NB60SL             |   |  |
|                         | 10.1 Current  10.1.2 Supplier Part No  2STP535FP  BDW93CFP  BDW94CFP  BUL1102EFP  D45H11FP  STGF10H60DF  STGF10N65DF2  STGF10NC60KD  STGF14NC60KD  STGF15H60DF  STGF15H60DF  STGF20H60DF  STGF20H65DF2  STGF30M65DF2  STGF3NC120HD  STGF4M65DF2  STGF5H60DF  STGF5H60DF  STGF5H60DF  STGF5H60DF  STGF6M65DF2  STGF6NC60HD  STGF7H60DF |  |



## **Public Products List**

Publict Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title: TO-220FP line transfer from Shenzhen to TFME

Tongke (China)

PCN Reference: ADG/24/14592

Subject: Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

| STGF7H60DF    | STGF14NC60KD  | 2STP535FP    |
|---------------|---------------|--------------|
| BDW94CFP      | STGF10H60DF   | STGF10NB60SD |
|               |               |              |
| STGF15H60DF   | STGF6M65DF2   | STGF5H60DF   |
| STGF19NC60KD  | STGF4M65DF2   | BUL1102EFP   |
| STGF20H60DF   | STGF20H65DFB2 | STGF6NC60HD  |
| STGF30H65DFB2 | BDW93CFP      | D45H11FP     |
| STGF20M65DF2  | STGF30M65DF2  | STGF10M65DF2 |
| STGF10NC60KD  | STGF7NB60SL   | STGF3NC120HD |
| STGF15M65DF2  |               |              |



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